


Note: R101 is a reworked part.

PCB: PMP9073 Rev A
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Number: PMP10765	Rev: A	Designed for: Public Release	Mod. Date: 10/14/2014
SVN Rev. Version control disabled	Assembly Variant: 001	Project Title: UCC28880 High-side Buck Converter	Sheet Title: 85Vac-265Vac to 18V/0.13A
Drawn By: S Yu	File: PMP9073_01.SchDoc	Sheet: 1 of 2	Size: B
Engineer: S Yu	Contact: http://www.ti.com/support	 http://www.ti.com © Texas Instruments 2014	

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